# A+ Server 2113S-WN24RT (Complete System Only)



**Integrated Board** 



**H11SSW-NT** 

Views: | <u>Angled View</u> | <u>Top View</u> | | <u>Front View</u> | <u>Rear View</u> |

**Complete System Only**: To maintain quality and integrity, this product is sold only as a completely-assembled system (with 1 CPU, minimum 8 DIMMs, 1 NVMe). Recommended configuration for best performance is at least 24 or 32 Cores per CPU.

► <u>Drivers & Utilities</u> ► <u>BIOS</u> ► <u>IPMI</u> ► <u>Tested Memory</u> ► <u>Tested M.2</u>
<u>List</u> ► <u>NVMe Options</u> ► <u>Tested AOC</u> ► <u>Manuals</u> ► <u>OS Certification</u>
<u>Matrix</u> ► <u>Quick-References Guide</u> ► <u>Drive Options</u>

Note: Image above may show a varied configuration of optional parts. Please refer to parts list for standard parts included.

#### **Key Features**

Virtualization
Hyperconverged Storage
Cloud Computing
All Flash Storage

- 1. Single AMD EPYC™ 7001/7002\* Series Processor (\*AMD EPYC 7002 series drop-in support requires board revision 2.x)
- 2. 2TB Registered ECC DDR4 2666MHz SDRAM in 16 DIMMs

4TB Registered ECC DDR4 3200MHz SDRAM in 16 DIMMs (Board revision 2.x required)

3. Expansion slots:

1 PCI-E 3.0 x16 (FH/HL) slot

M.2 Interface: PCI-E 3.0 x2 (NVMe based)

M.2 Form Factor: 2280, 22110 M.2 Key: Onboard M-key Number of M.2: Dual

- 4. Integrated IPMI 2.0 + KVM with dedicated LAN
  - Software Out of Band License key (SFT-OOB-LIC) included for OOB BIOS management
- 5. 2x 10GBase-T LAN ports via Broadcom BCM57416
- 6. 24 hot-swap 2.5" U.2 NVMe drive bays
- 7. 1200W Redundant Power Supplies

  Titanium Level (96%)

  (Full redundancy based on configuration and application load)



# **Specifications**

Product SKUs		Chassis		
AS -2113S-	A+ Server 2113S-WN24RT	Form Factor	■ 2U	
WN24RT		Model	CSE-216BTS-R1K23WBP	
Motherboard		Dimensions and V	Veight	
H11SSW-NT		Height	■ 3.5" (89mm)	
Processor/Chipset		Width	■ 17.2" (437mm)	
СРИ	■ Single AMD EPYC™ 7001/7002*	Depth	■ 24.8" (630mm)	
	series Processor (*Board revision 2.x	Package	■ 10.1" (H) 25.8" (W) 37.8" (D)	
	required) Socket SP3 Supports CPU TDP 225W / cTDP up to 240W*	Weight	<ul> <li>Net Weight: 34 lbs (15.42 kg)</li> <li>Gross Weight: 59 lbs (26.76 kg)</li> </ul>	
Cores	■ Up to 32 Cores (Board revision 1.x +	Front Panel		
Cores	7001 Processors)  Up to 64 Cores (Board revision 2.x + 7002 Processors)	Buttons	<ul><li>Power On/Off button</li><li>System Reset button</li></ul>	
Chipset	System on Chip (SoC)	LEDs	■ Power LED	
System Memory			<ul> <li>Hard drive activity LED</li> <li>2x Network activity LEDs</li> <li>System Overheat LED / Fan fail LED /</li> </ul>	
Memory Capacity	<ul><li>16 DIMM slots</li><li>Supports up to 2TB Registered ECC</li></ul>		UID LED	
- apacity	DDR4 2666MHz SDRAM (7001	Drive Bays		
	Processors) Supports up to 4TB Registered ECC DDR4 3200MHz SDRAM (Board	Hot-swap	<ul><li>24 hot-swap 2.5" U.2 NVMe drive bays</li></ul>	
	revision 2.x required + 7002 Processors)  8-channel memory bus	System Cooling		
Memory Type	■ DDR4 2666 MHz Registered ECC,	Fans	<ul><li>3 heavy-duty PWM fans with optimal fan speed control</li></ul>	
	288-pin gold-plated DIMMs (7001 Processors)	Air Shroud	■ 1 Air Shroud	
	<ul> <li>DDR4 3200 MHz Registered ECC, 288-pin gold-plated DIMMs (Board revision 2.x required + 7002</li> </ul>	Power Supply (76mm Width)  1200W Redundant Power Supplies with PMBus		
	Processors)			
DIMM Sizes	■ 4GB, 8GB, 16GB, 32GB, 64GB, 128GB, 256GB*	Total Output Power	■ 1000W/1200W	
	(* Board revision 2.x required + 7002 Processors)	Dimension (W x H x L)	■ 76 x 40 x 336 mm	
Memory Voltage	■ 1.2V	Input	■ 100-127Vac / 15-12A / 50-60Hz	
Error Detection	■ Corrects single-bit errors		<ul> <li>200-240Vac / 8.5-7A / 50-60Hz</li> <li>200-240Vdc / 8.5-7A (for CCC only)</li> </ul>	
On-Board Devices	<ul> <li>Detects double-bit errors (using ECC memory)</li> </ul>	+12V	<ul> <li>Max: 83A / Min: 0A (100-127Vac)</li> <li>Max: 100A / Min: 0A (200-240Vac)</li> <li>Max: 100A / Min: 0A (200-240Vdc)</li> </ul>	
IPMI	- Support for Intelligent Distform	+5Vsb	■ Max: 4A / Min: 0A	
it Mil	<ul> <li>Support for Intelligent Platform</li> <li>Management Interface v.2.0</li> </ul>	Output Type	■ 19 Pairs Gold Finger Connector	
	<ul> <li>IPMI 2.0 with virtual media over LAN and KVM-over-LAN support</li> </ul>	Certification	Titanium Level	
Materials	■ ASPEED AST2500 BMC		[ Test Report ]	
Network Controllers	■ Broadcom BCM57416 Controller	DO !! !!! !!	-	
VGA	■ ASPEED AST2500 BMC	PC Health Monitor		
Expansion Slots		CPU	<ul> <li>Monitors CPU Core Voltages, +1.8V, +3.3V, +5V, +5V standby, 3.3V standby, VBAT</li> </ul>	
PCI Express	■ 1 PCI-E 3.0 x16 (FH/HL) slot		<ul> <li>CPU switching voltage regulator</li> </ul>	
M.2	<ul> <li>Interface: PCI-E 3.0 x2 (NVMe based)</li> <li>Form Factor: 2280, 22110</li> <li>Key: Onboard M-key</li> <li>Number of M.2: Dual</li> </ul>			

In	ni	116	1	$\cap$	n rés	nı	14
1111	μι	иı	1	$\cup$	uц	μι	иı

NVMe	■ Up to 24 U.2 NVMe support	
LAN	<ul><li>2x 10GbBase-T LAN ports</li><li>1 RJ45 Dedicated IPMI LAN port</li></ul>	
USB	■ 5 USB 3.0 ports (4 rear + 1 Type A)	
VGA	■ 1 VGA port	
Others	<ul><li>1 COM port</li><li>2 SATA DOM power connectors</li><li>TPM 1.2 header</li></ul>	
System BIOS		
BIOS Type	■ AMI 128Mb SPI Flash EEPROM	
BIOS Features	<ul> <li>Plug and Play (PnP)</li> <li>DMI 2.3</li> <li>PCI 2.2</li> <li>ACPI 5.1</li> <li>USB Keyboard Support</li> <li>SMBIOS 3.1.1</li> </ul>	

FAN	<ul> <li>Up to 6-fan status tachometer monitoring</li> <li>Up to six 4-pin fan headers</li> <li>Status monitor for speed control</li> <li>Pulse Width Modulated (PWM) fan connectors</li> </ul>	
Temperature	<ul> <li>Monitoring for CPU and chassis environment</li> <li>CPU Thermal Trip Support</li> <li>Thermal control for 6x Fan connectors</li> <li>I²C Temperature Sensing Logic</li> </ul>	
LED	<ul><li>CPU / System Overheat LED</li></ul>	
Other Features	<ul><li>Chassis Intrusion Detection</li><li>Chassis Intrusion Header</li></ul>	
Operating Environment / Compliance		
RoHS	■ RoHS Compliant	

RoHS	■ RoHS Compliant
Environmental Spec.	<ul> <li>Operating Temperature:         10°C to 35°C (50°F to 95°F)</li> <li>Non-operating Temperature:         -40°C to 70°C (-40°F to 158°F)</li> <li>Operating Relative Humidity:         8% to 90% (non-condensing)</li> <li>Non-operating Relative Humidity:         5% to 95% (non-condensing)</li> </ul>

## **Parts List**

#### Parts List - (Items Included)

	Part Number	Qty	Description
Motherboard	MBD-H11SSW-NT	1	Super H11SSW-NT Motherboard
Chassis	CSE-216BTS- R1K23WBP	1	2U Chassis
HD Backplane	BPN-NVME3-216N-S4	1	24-port 2U (SC216/219) NVMe direct-attached backplane, support 24x 2.5-inch NVMe devices
Add-on Card	AOC-SLG3-2E4R-P	2	NVMe AOC by 8,HF,RoHS/REACH
Add-on Card	AOC-SLG3-4E4R-P	1	NVMe AOC by 16,HF,RoHS/REACH
Cable(s)	CBL-PWEX-1070	1	PWEX,2X2F/P4.2 TO 1X4M/P5.08 x2,BLK*2,YEL*2,40CM,16AWG
Cable(s)	CBL-PWEX-1071	1	PWEX,2X4F/P4.2 TO 2X2M/P4.2 x2,BLK*4,YEL*4,15/30CM,16AWG
Cable(s)	CBL-SAST-0815	6	SLIMLINE SAS x8 to 2x Oculink x4,INT, 22CM,34AWG
Cable(s)	CBL-SAST-0817	2	SLIMLINE SAS x8 (LA) to 2x Oculink x4,INT, 36CM,34AWG
Cable(s)	CBL-SAST-0841	4	MiniSAS HD source to OcuLink v 1.0,INT,PCIe, 76CM,34AWG,RoHS
Cable(s)	CBL-SAST-0849	4	MiniSAS HD source to OcuLink v 1.0,INT,PCle, 57CM,34AWG
Riser Card	RSC-R2UW-2E8R	1	2U RHS WIO Riser card with two PCI-E x8 slots
Riser Card	RSC-W2-66	1	RSC-W2-66
Heatsink / Retention	SNK-P0063P	1	2U Passive CPU Heat Sink for AMD Socket SP3 Processors
Mounting Rail(s)	MCP-290-00053-0N	1	Rail set, quick/quick, default for 2,3U 17.2";W
Fan(s)	FAN-0158L4	3	80x80x38 mm, 10.5K RPM, Optional Middle Cooling Fan for X10 2U Ultra and HFT Series Servers,RoHS/REACH
Software	SFT-OOB-LIC	1	License key for enabling OOB BIOS management

### **Optional Parts List**

	Part Number	Qty	Description
Parts	MCP-220-82616-0N	1	12G 2.5x2 Drive Kit w/ Status LED(216B/826B/417B/846X/847B)
Cable Management Arm	MCP-290-00073-0N MCP-120-82503-0N	-	Supermicro Cable Management Arm for 2U, 3U and 4U chassis Cable arm adapter for SC825,213,829H,847B (MCP-290-00073-0N required),HF,RoHS/REACH,PBF
TPM	AOM-TPM-9655V AOM-TPM-9665V	-	Vertical TPM with Infineon 9655 TCG 1.2  AOM-TPM-9665V using SLB9665 Chipset supporing
Global Services & Support	OS4HR3/2/1	-	TPM2.0,RoHS/REACH  3/2/1-year onsite 24x7x4 service
Software	OSNBD3/2/1 SFT-DCMS-Single	1	3/2/1-year onsite NBD service  DataCenter Management Package (per node license)